L Number	Hits	Search Text	DB	Time stamp
39	1	JP-11339242-\$.did.	JPO; DERWENT	2004/09/28
40	1	2000-211652.NRAN.	DERWENT	13:37 2004/09/28 13:37
38	2	JP-2001034938-\$.did.	JPO; DERWENT	2004/09/28 13:38
41	31	((((((((optical magnet\$4 compact master) near3 disc) (MRM MD CD master) (record\$3 near3 medium))	EPO; JPO; DERWENT;	2004/09/28 14:37
42	1412	and (etch\$4 ablat\$4 abrad\$4 form\$4 remov\$4 polish\$4)) and (groove track trench)) and (magnetic adj film)) and (mask resist photoresist etch?stop)) (((((((optical magnet\$4 compact master) near3 disc) (MRM MD CD master) (record\$3 near3 medium)) and (etch\$4 ablat\$4 abrad\$4 form\$4 remov\$4 polish\$4)) and (groove track trench)) and (magnetic	USPAT; US-PGPUB	2004/09/28 14:38
43	16641	adj film)) and (mask resist photoresist etch?stop)) master near5 (disc information medium recording)	USPAT;	2004/09/28
44	1153	(master near5 (disc information medium recording)) same magnetic	US-PGPUB USPAT;	14:39 2004/09/28
45	332	((master near5 (disc information medium recording)) same magnetic) same (groove trench	US-PGPUB USPAT; US-PGPUB	14:39 2004/09/28 14:39
46	8	track) (((master near5 (disc information medium recording)) same magnetic) same (groove trench	USPAT; US-PGPUB	2004/09/28 14:39
47	10	track)) same (silicon "Si") (((master near5 (disc information medium recording)) same magnetic) same (groove trench	USPAT; US-PGPUB	2004/09/28 14:39
48	0	track)) same (silicon "Si" semiconductor) 6613459.URPN.	USPAT	2004/09/28
49	7	("4363844" "5637373" "5677051" "5703733" "5768075" "6347016" "6433944").PN.	USPAT	2004/09/28
68	1643	(silicon adj dioxide silicon adj oxide "sio.sub.2") with (mask resist) with (silicon "Si") with (groove trench via track) with (etch\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/28 15:06
69	598	((silicon adj dioxide silicon adj oxide "sio.sub.2") with (mask resist) with (silicon "Si") with (groove trench via track) with (etch\$4)) same (thickness depth micron micrometer ".mu.")	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/28 15:06
70	29	(((silicon adj dioxide silicon adj oxide "sio.sub.2") with (mask resist) with (silicon "Si") with (groove trench via track) with (etch\$4)) same (thickness depth micron micrometer ".mu.")) and (disc disk)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/28 15:06
131	5	("4125427" "4180432" "4259433" "4350561" "4512848").PN.	USPAT	2004/09/28 15:31
132	18	4724043.URPN.	USPAT	2004/09/28 15:32
154	13	("3383760" "3859178" "4417946" "4437226" "4561932" "4670092" "4776924" "4814287" "4845048" "5072288" "5112771" "5156988" "5198390").PN.	USPAT	2004/09/28 15:41
155	59	5198390.URPN.	USPAT	2004/09/28 15:50
179	20	5770465.URPN.	USPAT	2004/09/28 16:05

180	63	(US-6788641-\$ or US-6623652-\$ or	HODAT.	0004/00/00
100	03		USPAT;	2004/09/28
		US-6419845-\$ or US-6264848-\$ or US-5700540-\$	US-PGPUB;	16:26
		or US-6402973-\$ or US-5770465-\$ or	EPO; JPO;	
•		US-6773782-\$ or US-6706358-\$ or US-5580639-\$	DERWENT;	
		or US-4057831-\$ or US-5998261-\$ or	IBM_TDB	
		US-6284606-\$ or US-5915192-\$ or US-6530141-\$		
		or US-6515475-\$ or US-5713122-\$ or		
		US-4608293-\$ or US-4299680-\$ or US-6613459-\$		
		or US-6583957-\$ or US-6242162-\$ or		
		US-4797316-\$ or US-4724043-\$ or US-5652687-\$		
		or US-4772929-\$).did. or (US-6020270-\$ or		
		US-6770388-\$ or US-5724339-\$ or US-5199023-\$		
		or US-6709976-\$ or US-6153443-\$ or		
		US-5242539-\$ or US-4983253-\$ or US-4452507-\$		
		or US-5393375-\$ or US-6090712-\$ or		
		US-5215623-\$ or US-5148257-\$ or US-5576918-\$		
		or US-6703099-\$ or US-6670032-\$).did. or		
		(US-20030136973-\$ or US-20020112343-\$ or		
		US-20020041463-\$ or US-20040076110-\$ or		
	-	US-20010031549-\$ or US-20020055018-\$).did. or		
		(EP-176684-\$).did. or (JP-63119038-\$ or		
		JP-04310642-\$ or JP-01235044-\$ or		
		JP-03263635-\$ or JP-63071957-\$ or		
		JP-03137821-\$ or JP-04325943-\$ or		
		JP-03209641-\$).did. or (JP-05189743-\$ or		
		JP-04251435-\$ or JP-07296328-\$ or	:	
		JP-2001034938-\$ or JP-11339242-\$).did. or		
		(NB8406505).tban.		
183	11	((US-6788641-\$ or US-6623652-\$ or	USPAT;	0004/00/00
100		US-6419845-\$ or US-6264848-\$ or US-5700540-\$	US-PGPUB;	2004/09/28 16:27
		or US-6402973-\$ or US-5770465-\$ or		10:27
		US-6773782-\$ or US-6706358-\$ or US-5580639-\$	EPO; JPO;	
		or US-4057831-\$ or US-5998261-\$ or	DERWENT;	
		US-6284606-\$ or US-5915192-\$ or US-6530141-\$	IBM_TDB	
		or US-6515475-\$ or US-5713122-\$ or		
		US-4608293-\$ or US-4299680-\$ or US-6613459-\$		
	1	or US-6583957-\$ or US-6242162-\$ or		
		US-4797316-\$ or US-4724043-\$ or US-5652687-\$		
		or US-4772929-\$).did. or (US-6020270-\$ or		
		US-6770388-\$ or US-5724339-\$ or US-5199023-\$		
		or US-6709976-\$ or US-6153443-\$ or		
		US-5242539-\$ or US-4983253-\$ or US-4452507-\$		
		or US-5393375-\$ or US-6090712-\$ or		
		or US-5393375-\$ or US-6090712-\$ or US-5215623-\$ or US-5148257-\$ or US-5576918-\$		
		or US-5393375-\$ or US-6090712-\$ or US-5215623-\$ or US-5148257-\$ or US-5576918-\$ or US-6703099-\$ or US-6670032-\$).did. or		
		or US-5393375-\$ or US-6090712-\$ or US-5215623-\$ or US-5148257-\$ or US-5576918-\$ or US-6703099-\$ or US-6670032-\$).did. or (US-20030136973-\$ or US-20020112343-\$ or		
		or US-5393375-\$ or US-6090712-\$ or US-5215623-\$ or US-5148257-\$ or US-5576918-\$ or US-6703099-\$ or US-6670032-\$).did. or (US-20030136973-\$ or US-20020112343-\$ or US-20020041463-\$ or US-20040076110-\$ or		
		or US-5393375-\$ or US-6090712-\$ or US-5215623-\$ or US-5148257-\$ or US-5576918-\$ or US-6703099-\$ or US-6670032-\$).did. or (US-20030136973-\$ or US-20020112343-\$ or US-20020041463-\$ or US-20040076110-\$ or US-20010031549-\$ or US-20020055018-\$).did. or		
		or US-5393375-\$ or US-6090712-\$ or US-5215623-\$ or US-5148257-\$ or US-5576918-\$ or US-6703099-\$ or US-6670032-\$).did. or (US-20030136973-\$ or US-20020112343-\$ or US-20020041463-\$ or US-20040076110-\$ or US-20010031549-\$ or US-20020055018-\$).did. or (EP-176684-\$).did. or (JP-63119038-\$ or		
		or US-5393375-\$ or US-6090712-\$ or US-5215623-\$ or US-5148257-\$ or US-5576918-\$ or US-6703099-\$ or US-6670032-\$).did. or (US-20030136973-\$ or US-20020112343-\$ or US-20020041463-\$ or US-20040076110-\$ or US-20010031549-\$ or US-20020055018-\$).did. or		
		or US-5393375-\$ or US-6090712-\$ or US-5215623-\$ or US-5148257-\$ or US-5576918-\$ or US-6703099-\$ or US-6670032-\$).did. or (US-20030136973-\$ or US-20020112343-\$ or US-20020041463-\$ or US-20040076110-\$ or US-20010031549-\$ or US-20020055018-\$).did. or (EP-176684-\$).did. or (JP-63119038-\$ or		
		or US-5393375-\$ or US-6090712-\$ or US-5215623-\$ or US-5148257-\$ or US-5576918-\$ or US-6703099-\$ or US-6670032-\$).did. or (US-20030136973-\$ or US-20020112343-\$ or US-20020041463-\$ or US-20040076110-\$ or US-20010031549-\$ or US-20020055018-\$).did. or (EP-176684-\$).did. or (JP-63119038-\$ or JP-04310642-\$ or JP-01235044-\$ or		·
		or US-5393375-\$ or US-6090712-\$ or US-5215623-\$ or US-5148257-\$ or US-5576918-\$ or US-6703099-\$ or US-6670032-\$).did. or (US-20030136973-\$ or US-20020112343-\$ or US-20020041463-\$ or US-20040076110-\$ or US-20010031549-\$ or US-20020055018-\$).did. or (EP-176684-\$).did. or (JP-63119038-\$ or JP-04310642-\$ or JP-01235044-\$ or JP-03263635-\$ or JP-63071957-\$ or		
		or US-5393375-\$ or US-6090712-\$ or US-5215623-\$ or US-5148257-\$ or US-5576918-\$ or US-6703099-\$ or US-6670032-\$).did. or (US-20030136973-\$ or US-20020112343-\$ or US-20020041463-\$ or US-20040076110-\$ or US-20010031549-\$ or US-20020055018-\$).did. or (EP-176684-\$).did. or (JP-63119038-\$ or JP-04310642-\$ or JP-01235044-\$ or JP-03263635-\$ or JP-63071957-\$ or JP-03137821-\$ or JP-04325943-\$ or JP-03209641-\$).did. or (JP-05189743-\$ or		
		or US-5393375-\$ or US-6090712-\$ or US-5215623-\$ or US-5148257-\$ or US-5576918-\$ or US-6703099-\$ or US-6670032-\$).did. or (US-20030136973-\$ or US-20020112343-\$ or US-20020041463-\$ or US-20040076110-\$ or US-20010031549-\$ or US-20020055018-\$).did. or (EP-176684-\$).did. or (JP-63119038-\$ or JP-04310642-\$ or JP-01235044-\$ or JP-03263635-\$ or JP-63071957-\$ or JP-03137821-\$ or JP-04325943-\$ or JP-03209641-\$).did. or (JP-05189743-\$ or JP-04251435-\$ or JP-07296328-\$ or		
		or US-5393375-\$ or US-6090712-\$ or US-5215623-\$ or US-5148257-\$ or US-5576918-\$ or US-6703099-\$ or US-6670032-\$).did. or (US-20030136973-\$ or US-20020112343-\$ or US-20020041463-\$ or US-20040076110-\$ or US-20010031549-\$ or US-20020055018-\$).did. or (EP-176684-\$).did. or (JP-63119038-\$ or JP-04310642-\$ or JP-01235044-\$ or JP-03263635-\$ or JP-63071957-\$ or JP-03137821-\$ or JP-04325943-\$ or JP-03209641-\$).did. or (JP-05189743-\$ or		

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-	298	("4279623"			USPAT	2004/09/22
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	571	(016 (00) 0010	T	T
-	571	(216/22).CCLS.	USPAT;	2004/09/22
			US-PGPUB;	12:15
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	351	((216/22).CCLS.) and (disc record\$3 adj medium)	USPAT;	2004/09/22
	ļ		US-PGPUB;	12:59
			EPO; JPO;	12.03
			DERWENT;	
	308	(216/39).CCLS.	IBM_TDB	2004/00/00
_	308	(210/39).CCL3.	USPAT;	2004/09/22
			US-PGPUB;	14:43
			EPO; JPO;	
			DERWENT;]
			IBM_TDB	
-	223	(216/72).CCLS.	USPAT;	2004/09/22
			US-PGPUB;	15:03
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	1641	(369/275.1).CCLS.	USPAT;	2004/09/22
		1 , ,	US-PGPUB;	15:03
			EPO; JPO;	13.03
			DERWENT;	
	1006	(260 1075 4) 001 0	IBM_TDB	
-	1936	(369/275.4).CCLS.	USPAT;	2004/09/22
			US-PGPUB;	15:03
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	3301	(369/283).CCLS.	USPAT;	2004/09/22
			US-PGPUB;	15:04
			EPO; JPO;	
			DERWENT;	
	,		IBM_TDB	
_	1266	(369/288).CCLS.		2004 (00 (00
	1200	(00)/200/.0020.	USPAT;	2004/09/22
			US-PGPUB;	15:04
			EPO; JPO;	
			DERWENT;	
		((0.50 (0.77 4) 0.07 5) (0.77 5)	IBM_TDB	
-	1396	(((369/275.1).CCLS.) ((369/275.4).CCLS.)	USPAT;	2004/09/22
		((369/283).CCLS.) ((369/288).CCLS.)) and (silicon	US-PGPUB;	18:53
		"si" "sio.sub.2")	EPO; JPO;	
			DERWENT;	
			IBM_TDB	[
-	204	((((369/275.1).CCLS.) ((369/275.4).CCLS.)	USPAT;	2004/09/22
		((369/283).CCLS.) ((369/288).CCLS.)) and (silicon	US-PGPUB;	15:05
		"si" "sio.sub.2")) and etch\$4	EPO; JPO;	-0.00
			DERWENT;	
ĺ			IBM_TDB	
	518	(((369/275.1).CCLS.) ((369/275.4).CCLS.)	_	0004700700
İ	310		USPAT;	2004/09/22
		((369/283).CCLS.) ((369/288).CCLS.)) and etch\$4	US-PGPUB;	15:35
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	314	((((369/275.1).CCLS.) ((369/275.4).CCLS.)	USPAT;	2004/09/22
		((369/283).CCLS.) ((369/288).CCLS.)) and etch\$4)	US-PGPUB;	15:59
		not ((((((369/275.1).CCLS.) ((369/275.4).CCLS.)	EPO; JPO;	
		((369/283).CCLS.) ((369/288).CCLS.)) and (silicon	DERWENT;	
		"si" "sio.sub.2")) and etch\$4)	IBM_TDB	
	···		ממו_זאומי	

				
-	1118	(216/79).CCLS.	USPAT;	2004/09/22
			US-PGPUB;	16:00
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	102	(216/74).CCLS.	USPAT;	2004/09/22
			US-PGPUB;	16:01
			EPO; JPO;	
			DERWENT;	
	1		IBM_TDB	
-	81	((216/79).CCLS.) and (disc record\$3 adj medium)	USPAT;	2004/09/22
1		((210) 13). Cobb.) and (disc record \$\phi \text{ adj incurally}	US-PGPUB;	16:33
				10.55
			EPO; JPO;	
			DERWENT;	
	5	5003670 LIDDN	IBM_TDB	
-	3	5993679.URPN.	USPAT	2004/09/22
	141110			16:10
-	141118	(disc record\$3 adj medium) with (magnet\$5	USPAT;	2004/09/22
		master)	US-PGPUB	17:08
-	437	((disc record\$3 adj medium) with (magnet\$5	USPAT;	2004/09/22
1		master)) same (groove? trench) same (etch\$4	US-PGPUB	16:35
		remov\$4 ablat\$4 abrad\$4 polish\$4)		
_	25	(((disc record\$3 adj medium) with (magnet\$5	USPAT;	2004/09/22
		master)) same (groove? trench) same (etch\$4	US-PGPUB	16:38
		remov\$4 ablat\$4 abrad\$4 polish\$4)) same (silicon		10.00
		silica\$4 "si" "sio.sub.2")		
·_	412	(((disc record\$3 adj medium) with (magnet\$5	USPAT;	2004/09/22
		master)) same (groove? trench) same (etch\$4	US-PGPUB	16:38
		remov\$4 ablat\$4 abrad\$4 polish\$4)) not ((((disc	03-1010	10:38
		record\$3 adj medium) with (magnet\$5 master))		
			i	
	i	same (groove? trench) same (etch\$4 remov\$4		
		ablat\$4 abrad\$4 polish\$4)) same (silicon silica\$4		
	10	"si" "sio.sub.2"))		
_	12	("3894179" "4307178" "4724043" "5147763"	USPAT	2004/09/22
		"5149607" "5286583" "5471455"		16:49
		"5645978" "5799007" "5898553" "5917799"		
		"6071586").PN.		
- .	0	6242162.URPN.	USPAT	2004/09/22
				16:50
-	456832	((optical magnet\$4 compact master) near3 disc)	USPAT;	2004/09/22
		(MRM MD CD) (record\$3 near3 medium)	US-PGPUB	17:47
-	58618	(((optical magnet\$4 compact master) near3 disc)	USPAT;	2004/09/22
		(MRM MD CD) (record\$3 near3 medium)) same	US-PGPUB	17:10
		(etch\$4 remov\$4 ablat\$4 abrad\$4 polish\$4)		
-	34651	(((optical magnet\$4 compact master) near3 disc)	USPAT;	2004/09/22
		(MRM MD CD) (record\$3 near3 medium)) with	US-PGPUB	17:10
		(etch\$4 remov\$4 ablat\$4 abrad\$4 polish\$4)		17,10
_	176	((((optical magnet\$4 compact master) near3 disc)	USPAT;	2004 /00 /00
	1.0	(MRM MD CD) (record\$3 near3 medium)) with		2004/09/22
[(etch\$4 remov\$4 ablat\$4 abrad\$4 polish\$4)) same	US-PGPUB	17:12
		(silicon silica\$4 "si") same (silicon adj dioxide		
		silicon adj oxide "sio.sub.2")		
_	172	Illiantical magnet 44 compact and 1 2 2 2	1100:	0004455
	1/4	(((((optical magnet\$4 compact master) near3 disc)	USPAT;	2004/09/22
		(MRM MD CD) (record\$3 near3 medium)) with	US-PGPUB	17:32
		(etch\$4 remov\$4 ablat\$4 abrad\$4 polish\$4)) same	ļ	
	İ	(silicon silica\$4 "si") same (silicon adj dioxide		
	i	silicon adj oxide "sio.sub.2")) not (((disc record\$3		
		adj medium) with (magnet\$5 master)) same		
		(groove? trench) same (etch\$4 remov\$4 ablat\$4		
		abrad\$4 polish\$4))		

-	1936	((((optical magnet\$4 compact master) near3 disc)	USPAT;	2004/09/22
		(MRM MD CD) (record\$3 near3 medium)) with	US-PGPUB	17:33
		(etch\$4 remov\$4 ablat\$4 abrad\$4 polish\$4)) same		
	0.5	(groove trench track)		
-	25	(title 1	USPAT;	2004/09/22
		(MRM MD CD) (record\$3 near3 medium)) with	US-PGPUB	17:40
		(etch\$4 remov\$4 ablat\$4 abrad\$4 polish\$4)) same		
	_	(groove trench track)) same (magnetic adj film)		
-	5	("4935278" "5768075" "6055139" "6180208"	USPAT	2004/09/22
		"6268978").PN.		17:35
-	60	(((((optical magnet\$4 compact master) near3 disc)	USPAT;	2004/09/22
		(MRM MD CD) (record\$3 near3 medium)) with	US-PGPUB	17:41
		(etch\$4 remov\$4 ablat\$4 abrad\$4 polish\$4)) same		
		(groove trench track)) same (silicon "si" "sio.sub.2")		
-	59	((((((optical magnet\$4 compact master) near3 disc)	USPAT;	2004/09/22
		(MRM MD CD) (record\$3 near3 medium)) with	US-PGPUB	17:41
		(etch\$4 remov\$4 ablat\$4 abrad\$4 polish\$4)) same		
		(groove trench track)) same (silicon "si" "sio.sub.2"))		
		not ((((((optical magnet\$4 compact master) near3		
		disc) (MRM MD CD) (record\$3 near3 medium))		
		with (etch\$4 remov\$4 ablat\$4 abrad\$4 polish\$4))		
1		same (groove trench track)) same (magnetic adj		
		film))		
-	960928	((optical magnet\$4 compact master) near3 disc)	EPO; JPO;	2004/09/22
		(MRM MD CD) (record\$3 near3 medium)	DERWENT;	17:47
			IBM_TDB	
-	382067	(((optical magnet\$4 compact master) near3 disc)	EPO; JPO;	2004/09/22
		(MRM MD CD) (record\$3 near3 medium)) and	DERWENT;	17:48
		(etch\$4 ablat\$4 abrad\$4 form\$4 remov\$4	IBM_TDB	
		polish\$4)		
-	27907	((((optical magnet\$4 compact master) near3 disc)	EPO; JPO;	2004/09/22
		(MRM MD CD) (record\$3 near3 medium)) and	DERWENT;	17:48
		(etch\$4 ablat\$4 abrad\$4 form\$4 remov\$4	IBM_TDB	
		polish\$4)) and (groove track trench)		
-	6701	(((((optical magnet\$4 compact master) near3 disc)	EPO; JPO;	2004/09/22
	1	(MRM MD CD) (record\$3 near3 medium)) and	DERWENT;	17:49
		(etch\$4 ablat\$4 abrad\$4 form\$4 remov\$4	IBM_TDB	
ļ.		polish\$4)) and (groove track trench)) and (silicon		
		"si" "sio.sub.2" silica)		
-	0	((((((optical magnet\$4 compact master) near3 disc)	EPO; JPO;	2004/09/22
		(MRM MD CD) (record\$3 near3 medium)) and	DERWENT;	17:49
		(etch\$4 ablat\$4 abrad\$4 form\$4 remov\$4	IBM_TDB	
		polish\$4)) and (groove track trench)) and (silicon		
		"si" "sio.sub.2" silica)) and (fill deposit smooth) and		
:	20	(magnetic adj film)		
	36	((((((optical magnet\$4 compact master) near3 disc)	EPO; JPO;	2004/09/22
		(MRM MD CD) (record\$3 near3 medium)) and	DERWENT;	17:52
		(etch\$4 ablat\$4 abrad\$4 form\$4 remov\$4	IBM_TDB	
		polish\$4)) and (groove track trench)) and (silicon		
_	545	"si" "sio.sub.2" silica)) and (magnetic adj film)	DDO IDO	2004/00/25
_	343	((((optical magnet\$4 compact master) near3 disc)	EPO; JPO;	2004/09/22
		(MRM MD CD) (record\$3 near3 medium)) and	DERWENT;	17:52
		(etch\$4 ablat\$4 abrad\$4 form\$4 remov\$4	IBM_TDB	
		polish\$4)) and (groove track trench)) and (magnetic		
_	31	adj film)	BB0	
-	31	((((((optical magnet\$4 compact master) near3 disc)	EPO; JPO;	2004/09/22
		(MRM MD CD) (record\$3 near3 medium)) and	DERWENT;	17:53
		(etch\$4 ablat\$4 abrad\$4 form\$4 remov\$4	IBM_TDB	
		polish\$4)) and (groove track trench)) and (magnetic		
		adj film)) and (mask resist photoresist etch?stop)		

-	29	1 mm 1	EPO; JPO;	2004/09/28
		(MRM MD CD) (record\$3 near3 medium)) and	DERWENT;	13:53
		(etch\$4 ablat\$4 abrad\$4 form\$4 remov\$4	IBM_TDB	
		polish\$4)) and (groove track trench)) and (magnetic		
		adj film)) and (mask resist photoresist etch?stop))		
		not ((((((((optical magnet\$4 compact master) near3		
		disc) (MRM MD CD) (record\$3 near3 medium)) and		
		(etch\$4 ablat\$4 abrad\$4 form\$4 remov\$4		
		polish\$4)) and (groove track trench)) and (silicon "si" "sio.sub.2" silica)) and (magnetic adj film))		
_	2602	(etch\$4) with (silicon) same ((silicon adj oxide	HCDAT.	0004 /00 /00
	2002	silicon adj dioxide "sio.sub.2") with (mask resist	USPAT; US-PGPUB	2004/09/22 18:50
		etch?stop)) same (groove track trench)	US-FGFUB	16:50
_	19	(disc record\$3 adj medium).ti,ab,clm. and ((etch\$4)	USPAT;	2004/09/23
		with (silicon) same ((silicon adj oxide silicon adj	US-PGPUB	11:26
		dioxide "sio.sub.2") with (mask resist etch?stop))	05-1 01 01	11.20
		same (groove track trench))		
_	14		EPO; JPO;	2004/09/22
		adj dioxide "sio.sub.2") and (mask resist	DERWENT;	18:41
		etch?stop)) and (groove track trench) and (disc	IBM_TDB	= 31
		record\$3 adj medium)		
-	2	JP-07296328-\$.did.	JPO;	2004/09/23
			DERWENT	13:11
-	1	1996-024856.NRAN.	DERWENT	2004/09/22
				18:45
-	1	((etch\$4) with (silicon) same ((silicon adj oxide	USPAT;	2004/09/22
	İ	silicon adj dioxide "sio.sub.2") with (mask resist	US-PGPUB	18:51
		etch?stop)) same (groove track trench)) same		
		(deposit fill apply) same (magnetic)		
-	12	((etch\$4) with (silicon) same ((silicon adj oxide	USPAT;	2004/09/22
		silicon adj dioxide "sio.sub.2") with (mask resist	US-PGPUB	18:51
		etch?stop)) same (groove track trench)) same		
	267	(magnetic)	1100.40	2224/22/22
-	207	(((369/275.1).CCLS.) ((369/275.4).CCLS.)	USPAT;	2004/09/22
	1	((369/283).CCLS.) ((369/288).CCLS.)) and ("magnetic film")	US-PGPUB;	18:54
		(magnetic mm)	EPO; JPO; DERWENT;	
			IBM_TDB	
_	230	((((369/275.1).CCLS.) ((369/275.4).CCLS.)	USPAT;	2004/09/22
		((369/283).CCLS.) ((369/288).CCLS.)) and	US-PGPUB;	18:54
		("magnetic film")) not ((((369/275.1).CCLS.)	EPO; JPO;	10.07
		((369/275.4).CCLS.) ((369/283).CCLS.)	DERWENT;	
	1	((369/288).CCLS.)) and etch\$4)	IBM_TDB	
-	67	(disc record\$3 adj medium magnetic).ti,ab,clm.	USPAT;	2004/09/23
		and ((etch\$4) with (silicon) same ((silicon adj oxide	US-PGPUB	12:03
		silicon adj dioxide "sio.sub.2") with (mask resist		[
		etch?stop)) same (groove track trench))		
-	2612	((etch\$4) with (silicon) same ((silicon adj oxide	USPAT;	2004/09/23
i		silicon adj dioxide "sio.sub.2") with (mask resist	US-PGPUB	15:11
		etch?stop)) same (groove track trench))		
-	1629	(((etch\$4) with (silicon) same ((silicon adj oxide	USPAT;	2004/09/23
		silicon adj dioxide "sio.sub.2") with (mask resist	US-PGPUB	13:06
		etch?stop)) same (groove track trench))) same (coat		
		apply deposit film sputter cover fill)		
-	10	(((etch\$4) with (silicon) same ((silicon adj oxide	USPAT;	2004/09/23
		silicon adj dioxide "sio.sub.2") with (mask resist	US-PGPUB	12:20
		etch?stop)) same (groove track trench))) same ((coat		
ļ		apply deposit film sputter cover fill) with		
_	241	(magnet\$4 ferromagnet\$4))	LIGDAT.	2004/00/5
-	341	(((etch\$4) with (silicon) same ((silicon adj oxide	USPAT;	2004/09/23
		silicon adj dioxide "sio.sub.2") with (mask resist etch?stop)) same (groove track trench))) same ((coat	US-PGPUB	14:48
		cover fill)		
	0/09/0	tovor mijj		

-	3	(((street t) train (smooth) same ((smooth day skide	USPAT;	2004/09/23
		silicon adj dioxide "sio.sub.2") with (mask resist	US-PGPUB	13:06
	_	etch?stop)) same (groove track trench))) same (disc)	Ì	
-	1	1996-024856.NRAN.	DERWENT	2004/09/23
	١,	(HECEOCOEII) DNI		13:07
-	1	("5652687").PN.	USPAT	2004/09/23
_	14	("3614339" "4550353" "4551911" "4675986"	LICDAT	13:11
	1.	"4689877" "4839197" "4843507"	USPAT	2004/09/23
		"4878290" "5111352" "5282308" "5283942"		13.11
		"5285340" "5289325" "5452164").PN.		
_	61	5652687.URPN.	USPAT	2004/09/23
				13:12
-	0	176684.URPN.	USPAT	2004/09/23
				13:46
-	0	176684.URPN.	USPAT	2004/09/23
				13:46
-	7	("5047274" "5277960" "5356513" "5576918"	USPAT	2004/09/23
	0.5	"5820769" "5923511" "6055139").PN.		13:54
-	25	5576918.URPN.	USPAT	2004/09/23
	6	6064848 UDDN	HODIM	13:56
-	6	6264848.URPN.	USPAT	2004/09/23
_	28	 ("4546398" "4735840" "4974110" "RE33949"	USPAT	13:58
	20	1 "5241520" "5399372" "5518804"	USFAI	2004/09/23 14:01
		"5543221" "5589262" "5615205" "5635267"		14.01
		"5703733" "5889641" "5942342"		
		"5986978" "5999512" "6042927" "6248416"		
		"6261681" "6264848" "6270885"		
		"6277484" "6387483" "6403240" "6411459"		
		"6421313" "6462916" "6531202"		
	_	"2001/0045005").PN.		
-	0	6703099.URPN.	USPAT	2004/09/23
	1	ID 04176001 & 4:4	· · · · · · · · · · · · · · · · · · ·	14:06
	1	JP-04176021-\$.did.	JPO;	2004/09/23
_	1	JP-03263635-\$.did.	DERWENT JPO:	14:08 2004/09/23
	_	or consect plana.	DERWENT	14:25
-	450	yoshimura-hiroyuki.in.	USPAT;	2004/09/23
			US-PGPUB;	15:12
			EPO; JPO;	
			DERWENT;	
i			IBM_TDB	
-	33	yoshimura-hiroyuki.in. and disc	USPAT;	2004/09/23
] [US-PGPUB;	15:20
			EPO; JPO;	
			DERWENT;	
-	74549	"fuji electric".as.	IBM_TDB USPAT;	2004/09/23
		9- 31000110 (00)	US-PGPUB;	15:21
			EPO; JPO;	10.41
[DERWENT;	
			IBM_TDB	
-	2306	"fuji electric".as. and disc	USPAT;	2004/09/23
			US-PGPUB;	15:21
			EPO; JPO;	
			DERWENT;	
[384	("fivii alaatria" aa amd diaa)	IBM_TDB	
-	364	("fuji electric".as. and disc) and (groove trench track)	USPAT;	2004/09/23
	İ	uccej	US-PGPUB;	15:24
			EPO; JPO;	
			DERWENT; IBM_TDB	
0 1 17. 4	0.100.10	4.5-10-10 DM Dogo 9	םחו"ואוחי	

-	9	(("fuji electric".as. and disc) and (groove trench track)) and etch\$4	USPAT; US-PGPUB;	2004/09/23 15:22
			EPO; JPO; DERWENT;	
		(MC ::)	IBM_TDB	
-	4	(("fuji electric".as. and disc) and (groove trench track)) and fill	USPAT;	2004/09/23
		track)) and mi	US-PGPUB; EPO; JPO;	16:11
			DERWENT;	
			IBM_TDB	
-	2618	(fill cover) with (groove track trench) same (etch)	USPAT;	2004/09/23
	10	(/6:11	US-PGPUB	16:27
-	12	((fill cover) with (groove track trench) same (etch)) same magnetic	USPAT;	2004/09/23
-	15		US-PGPUB USPAT	16:13 2004/09/23
		"5658826" "5710066" "5719089"	OSIAI	16:15
		"5802700" "5863707" "5867890" "5907775"		
		"5910871" "6100014" "6136696"	,	
	017	"6140201" "2003/0128460").PN.		
_	817	(fill cover) with (groove track trench) same ((etch) with (silicon silica\$4 "si" "sio.sub.2"))	USPAT;	2004/09/23
-	63	((fill cover) with (groove track trench) same ((etch)	US-PGPUB USPAT;	16:28 2004/09/23
		with (silicon silica\$4 "si" "sio.sub.2"))) same	US-PGPUB	16:46
		((silicon adj dioxide silicon adj oxide) with (mask		
		resist etch?stop hard?mask))		
-	571	(428/694ML).CCLS.	USPAT;	2004/09/23
			US-PGPUB; EPO; JPO;	17:22
			DERWENT;	
			IBM_TDB	
-	232	((428/694ML).CCLS.) and (groove trench track)	USPAT;	2004/09/23
			US-PGPUB;	16:48
			EPO; JPO; DERWENT;	
			IBM_TDB	
-	1	"5407755".PN.	USPAT	2004/09/23
	_			17:03
_	1	5700540.URPN.	USPAT	2004/09/23
_	1268	(428/694T).CCLS.	USPAT;	17:03
	1200	(126) 63 11).6686.	US-PGPUB;	2004/09/23 17:41
			EPO; JPO;	
	·		DERWENT;	
_	271	((428/604T) COLS) and (magazine)	IBM_TDB	2004/00/20
-	2/1	((428/694T).CCLS.) and (groove track trench)	USPAT; US-PGPUB;	2004/09/23
			EPO; JPO;	17:23
			DERWENT;	
	0.5-	/// 100 /50 ATD 007 0	IBM_TDB	
-	265	(((428/694T).CCLS.) and (groove track trench)) not	USPAT;	2004/09/23
		(((428/694ML).CCLS.) and (groove trench track))	US-PGPUB;	17:23
			EPO; JPO; DERWENT;	
			IBM_TDB	
-	2	("4565734" "4889767").PN.	USPAT	2004/09/23
	_	5571505 UDDN		17:29
-	0	5571595.URPN.	USPAT	2004/09/23
_	319	(428/694BR).CCLS.	USPAT;	17:29 2004/09/23
		, , , , , , , , , , , , , , , , , , , ,	US-PGPUB;	17:50
			EPO; JPO;	
			DERWENT;	
	0./00./0	4 5:10:10 DM D- 0	IBM_TDB	

	07	T ((400 (60 4PP) 0010)	T	
-	97	((428/694BR).CCLS.) and (groove track trench)	USPAT;	2004/09/23
			US-PGPUB;	17:46
			EPO; JPO;	
			DERWENT;	
	404	/400 /60 4 GTV GOV G	IBM_TDB	
-	494	(428/694ST).CCLS.	USPAT;	2004/09/23
	1		US-PGPUB;	17:51
			EPO; JPO;	
			DERWENT;	
	100	//400 /5040Th 0010 h	IBM_TDB	
-	126	((428/694ST).CCLS.) and (groove track trench)	USPAT;	2004/09/23
			US-PGPUB;	17:51
			EPO; JPO;	
			DERWENT;	
*	C 1.1	(400 (60 400) 0010	IBM_TDB	
-	644	(428/694SG).CCLS.	USPAT;	2004/09/23
			US-PGPUB;	17:51
			EPO; JPO;	
			DERWENT;	
	200	W400 (C0400) 0012 :	IBM_TDB	
-	209	((428/694SG).CCLS.) and (groove track trench)	USPAT;	2004/09/23
			US-PGPUB;	17:51
			EPO; JPO;	
			DERWENT;	
		/// // // // // // // // // // // // //	IBM_TDB	
-	8	("3099571" "4391849" "4472240" "4875987"	USPAT	2004/09/23
		"4911967" "4935278" "5336586"		18:02
	_	"5350618").PN.		
-	4	5580639.URPN.	USPAT	2004/09/23
	10	("2004170" "4007170" "4504040" "774		18:03
_	12	["3894179" "4307178" "4724043" "5147763"	USPAT	2004/09/24
		"5149607" "5286583" "5471455"		16:33
		"5645978" "5799007" "5898553" "5917799"		
	447	"6071586").PN.		
-	447	(trifluoromethane "chf.sub.3") with (oxygen	USPAT;	2004/09/24
		"o.sub.2") with (silicon adj dioxide silicon adj oxide	US-PGPUB;	16:52
		"sio.sub.2")	EPO; JPO;	
			DERWENT;	
	A1E	(trifluoromothono "akf oak 2" - 41. (IBM_TDB	0004/00/01
-	415	((trifluoromethane "chf.sub.3") with (oxygen	USPAT;	2004/09/24
		"o.sub.2") with (silicon adj dioxide silicon adj oxide	US-PGPUB;	16:52
	İ	"sio.sub.2")) with etch\$4	EPO; JPO;	
			DERWENT;	
1_	46	(((trifluoromethane "chf.sub.3") with (oxygen	IBM_TDB	0004/00/04
	70	"o.sub.2") with (silicon adj dioxide silicon adj oxide	USPAT;	2004/09/24
	ļ		US-PGPUB;	16:59
		"sio.sub.2")) with etch\$4) with (trench groove via track)	EPO; JPO;	
		uackj	DERWENT;	
_	198	(sulfur adi fluorida culfur adi hazzati -	IBM_TDB	0004/00/07
-	190	(sulfur adj fluoride sulfur adj hexafluoride	USPAT;	2004/09/27
		"sf.sub.6") with (silicon "Si") with (groove trench via track) with (etch\$4)	US-PGPUB;	13:38
		uack, with (Etchip4)	EPO; JPO;	
	ļ		DERWENT;	
	29	(silicon adj dioxide silicon adj oxide "sio.sub.2")	IBM_TDB	0004/00/00
	29	with (mask resist) same ((sulfur adj fluoride sulfur	USPAT;	2004/09/28
		adj hexafluoride "sf.sub.6") with (silicon "Si") with	US-PGPUB;	15:05
		(groove trench via track) with (etch\$4))	EPO; JPO;	
		(Broove deficit via dack) with (etch\$4))	DERWENT;	
L			IBM_TDB	

			·	.
_	16043	(width depth dimension) with (trench groove track) same (disc magnetic adj record)	USPAT; US-PGPUB;	2004/09/24 17:29
			EPO; JPO; DERWENT;	
			IBM_TDB	
-	42	["	USPAT;	2004/09/24
		same (disc magnetic adj record)) same (silicon "si")	US-PGPUB;	17:11
		same (silicon adj oxide silicon adj dioxide	EPO; JPO;	
		"sio.sub.2")	DERWENT;	
	004		IBM_TDB	
-	904	(width depth dimension) with (trench groove track)	USPAT;	2004/09/24
		with narrow same (disc magnetic adj record)	US-PGPUB;	17:40
			EPO; JPO; DERWENT;	
			IBM_TDB	
_	5	((width depth dimension) with (trench groove track)	USPAT;	2004/09/24
		with narrow same (disc magnetic adj record)) same	US-PGPUB;	17:29
		(silicon "si")	EPO; JPO;	17.25
		,	DERWENT;	
1			IBM_TDB	
-	370	((width depth dimension) with (trench groove track)	USPAT;	2004/09/24
		with narrow same (disc magnetic adj record)) same	US-PGPUB;	17:32
		(data information)	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	0	(((width depth dimension) with (trench groove	USPAT;	2004/09/24
		track) with narrow same (disc magnetic adj	US-PGPUB;	17:33
İ		record)) same (silicon "si")) same (micron	EPO; JPO;	
		micrometer "mum")	DERWENT;	
_	26	(((width depth dimension) with (trench groove	IBM_TDB	0004/00/04
	20	track) with narrow same (disc magnetic adj	USPAT; US-PGPUB;	2004/09/24 17:33
		record)) same (data information)) same (micron	EPO; JPO;	17.55
		micrometer "mum")	DERWENT;	
		,	IBM_TDB	
-	6904	(depth deep shallow) with (trench groove track)	USPAT;	2004/09/24
		same (disc magnetic adj record)	US-PGPUB;	17:41
	ļ		EPO; JPO;	
			DERWENT;	
	405	((1(1-1-1-1-1-1-1-1-1-1-1-1-1-1-1-1-1	IBM_TDB	
-	407	((depth deep shallow) with (trench groove track)	USPAT;	2004/09/24
		same (disc magnetic adj record)) same (micron "mum" micrometer)	US-PGPUB;	17:41
		mam micrometer)	EPO; JPO;	
			DERWENT; IBM_TDB	
_	46	(((depth deep shallow) with (trench groove track)	USPAT;	2004/09/24
		same (disc magnetic adj record)) same (micron	US-PGPUB;	17:51
		"mum" micrometer)) same magnetic	EPO; JPO;	
		0	DERWENT;	
İ			IBM_TDB	
-	7	(disc magnetic adj record\$4) same ((silicon adj	USPAT;	2004/09/24
		oxide silicon adj dioxide "sio.sub.2") with (mask	US-PGPUB;	17:55
		etch?stop resist) with (etch\$4) with (thick	EPO; JPO;	
	ĺ	thickness micron ".mu." micrometre nanometer))	DERWENT;	
		(diagram and a diagram)	IBM_TDB	
-	9	(disc magnetic adj record\$4) same etch\$4 same	USPAT;	2004/09/24
		((silicon adj oxide silicon adj dioxide "sio.sub.2") with (mask etch?stop resist) with (thick thin	US-PGPUB;	17:57
		thickness micron ".mu." micrometre nanometer))	EPO; JPO; DERWENT;	
		merometre nanometer))	IBM_TDB	
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-	2	((disc magnetic adj record\$4) same etch\$4 same	USPAT;	2004/09/24
		((silicon adj oxide silicon adj dioxide "sio.sub.2")	US-PGPUB;	17:57
		with (mask etch?stop resist) with (thick thin	EPO; JPO;	11.01
		thickness micron ".mu." micrometre nanometer)))	DERWENT;	
-		not ((disc magnetic adj record\$4) same ((silicon adj	IBM_TDB	
		oxide silicon adj dioxide "sio.sub.2") with (mask	15	
		etch?stop resist) with (etch\$4) with (thick		
		thickness micron ".mu." micrometre nanometer)))		
_	7	("4363844" "5637373" "5677051" "5703733"	USPAT	2004/09/27
		"5768075" "6347016" "6433944").PN.	001111	12:37
-	220	(sulfur adj fluoride sulfur adj hexafluoride	USPAT;	2004/09/27
		"sf.sub.6") with (silicon "Si") with (groove trench via	US-PGPUB;	13:39
		track) with (etch\$4) with (vapor gas RIE plasma)	EPO; JPO;	10.05
		, (ver v.) week (verper gas rain paroma)	DERWENT;	
			IBM_TDB	
-	58	(US-5713122-\$ or US-4608293-\$ or	USPAT;	2004/09/27
		US-4299680-\$ or US-6788641-\$ or US-6623652-\$	US-PGPUB:	13:45
		or US-6419845-\$ or US-6264848-\$ or	EPO; JPO;	10.10
		US-6402973-\$ or US-5770465-\$ or US-6706358-\$	DERWENT;	
		or US-5580639-\$ or US-4057831-\$ or	IBM_TDB	
		US-5700540-\$ or US-6613459-\$ or US-6583957-\$	12.11_122	
		or US-6242162-\$ or US-4797316-\$ or		
		US-4724043-\$ or US-5652687-\$ or US-4772929-\$		
		or US-6020270-\$ or US-6770388-\$ or		
		US-5724339-\$ or US-5199023-\$ or US-6709976-\$		
		or US-6153443-\$).did. or (US-4983253-\$ or		
		US-5242539-\$ or US-4452507-\$ or US-5393375-\$		
	l	or US-6090712-\$ or US-5215623-\$ or		
		US-5148257-\$ or US-5576918-\$ or US-6703099-\$		
		or US-6670032-\$ or US-5998261 - \$ or		
	İ	US-6284606-\$ or US-5915192-\$ or US-6530141-\$		
		or US-6515475-\$).did. or (US-20020041463-\$ or		
	-	US-20040076110-\$ or US-20010031549-\$ or		
		US-20030136973-\$ or US-20020112343-\$).did. or		
		(EP-176684-\$).did. or (JP-63119038-\$ or		
		JP-03263635-\$ or JP-63071957-\$ or		
		JP-04310642-\$ or JP-01235044-\$ or		
Ì		JP-04325943-\$ or JP-03209641-\$).did. or		
		(JP-07296328-\$ or JP-05189743-\$ or		
		JP-04251435-\$).did. or (NB8406505).tban.	İ	

		WYO 5710100 A		
-	29	((====================================	USPAT;	2004/09/27
		US-4299680-\$ or US-6788641-\$ or US-6623652-\$	US-PGPUB;	14:31
		or US-6419845-\$ or US-6264848-\$ or	EPO; JPO;	
		US-6402973-\$ or US-5770465-\$ or US-6706358-\$	DERWENT;	
		or US-5580639-\$ or US-4057831-\$ or	IBM_TDB	
		US-5700540-\$ or US-6613459-\$ or US-6583957-\$		
		or US-6242162-\$ or US-4797316-\$ or		
		US-4724043-\$ or US-5652687-\$ or US-4772929 - \$		
		or US-6020270-\$ or US-6770388-\$ or		
		US-5724339-\$ or US-5199023-\$ or US-6709976-\$		
		or US-6153443-\$).did. or (US-4983253-\$ or		
		US-5242539-\$ or US-4452507-\$ or US-5393375-\$		
		or US-6090712-\$ or US-5215623-\$ or		
		US-5148257-\$ or US-5576918-\$ or US-6703099-\$		
		or US-6670032-\$ or US-5998261-\$ or		
		US-6284606-\$ or US-5915192-\$ or US-6530141-\$		
		or US-6515475-\$).did. or (US-20020041463-\$ or		
		US-20040076110-\$ or US-20010031549-\$ or		
·		US-20030136973-\$ or US-20020112343-\$).did. or		
		(EP-176684-\$).did. or (JP-63119038-\$ or		
		JP-03263635-\$ or JP-63071957-\$ or		
		JP-04310642-\$ or JP-01235044-\$ or		
		JP-04325943-\$ or JP-03209641-\$).did. or		
		(JP-07296328-\$ or JP-05189743-\$ or		
		JP-04251435-\$).did. or (NB8406505).tban.) and		
		((groove track trench) with (depth height))		

-	29	((USPAT;	2004/09/27
		US-4299680-\$ or US-6788641-\$ or US-6623652-\$	US-PGPUB;	13:54
		or US-6419845-\$ or US-6264848-\$ or	EPO; JPO;	
		US-6402973-\$ or US-5770465-\$ or US-6706358-\$ or US-5580639-\$ or US-4057831-\$ or	DERWENT;	
		US-5700540-\$ or US-6613459-\$ or US-6583957-\$	IBM_TDB	
		or US-6242162-\$ or US-4797316-\$ or		
		US-4724043-\$ or US-5652687-\$ or US-4772929-\$		
		or US-6020270-\$ or US-6770388-\$ or		
		US-5724339-\$ or US-5199023-\$ or US-6709976-\$		
		or US-6153443-\$).did. or (US-4983253-\$ or		
		US-5242539-\$ or US-4452507-\$ or US-5393375-\$		
		or US-6090712-\$ or US-5215623-\$ or		
		US-5148257-\$ or US-5576918-\$ or US-6703099-\$		
		or US-6670032-\$ or US-5998261-\$ or		
		US-6284606-\$ or US-5915192-\$ or US-6530141-\$		
		or US-6515475-\$).did. or (US-20020041463-\$ or		
		US-20040076110-\$ or US-20010031549-\$ or		
		US-20030136973-\$ or US-20020112343-\$).did. or		
		(EP-176684-\$).did. or (JP-63119038-\$ or		[
		JP-03263635-\$ or JP-63071957-\$ or		
		JP-04310642-\$ or JP-01235044-\$ or		
		JP-04325943-\$ or JP-03209641-\$).did. or		
		(JP-07296328-\$ or JP-05189743-\$ or		
		JP-04251435-\$).did. or (NB8406505).tban.) not		
		(((US-5713122-\$ or US-4608293-\$ or		
		US-4299680-\$ or US-6788641-\$ or US-6623652-\$		
		or US-6419845-\$ or US-6264848-\$ or		
		US-6402973-\$ or US-5770465-\$ or US-6706358-\$		
		or US-5580639-\$ or US-4057831-\$ or		
		US-5700540-\$ or US-6613459-\$ or US-6583957-\$		
		or US-6242162-\$ or US-4797316-\$ or		
		US-4724043-\$ or US-5652687-\$ or US-4772929-\$		
		or US-6020270-\$ or US-6770388-\$ or		
		US-5724339-\$ or US-5199023-\$ or US-6709976-\$		
		or US-6153443-\$).did. or (US-4983253-\$ or		
		US-5242539-\$ or US-4452507-\$ or US-5393375-\$		
		or US-6090712-\$ or US-5215623-\$ or		
		US-5148257-\$ or US-5576918-\$ or US-6703099-\$		
		or US-6670032-\$ or US-5998261-\$ or		
		US-6284606-\$ or US-5915192-\$ or US-6530141-\$		
		or US-6515475-\$).did. or (US-20020041463-\$ or		
		US-20040076110-\$ or US-20010031549-\$ or		
		US-20030136973-\$ or US-20020112343-\$).did. or		
		(EP-176684-\$).did. or (JP-63119038-\$ or		
1		JP-03263635-\$ or JP-63071957-\$ or JP-04310642-\$ or JP-01235044-\$ or		
		JP-04325943-\$ or JP-03209641-\$).did. or (JP-07296328-\$ or JP-05189743-\$ or		
		JP-04251435-\$).did. or (NB8406505).tban.) and		
		((groove track trench) with (depth height)))		
_	1	1993-275581.NRAN.	DEDUIENA	2004/00/07
	1	1550 270001.HIGH,	DERWENT	2004/09/27
_	9495	(disc magnetic adj recording magnetic adj	USPAT;	14:10
	,,,,,	medium).ti,ab,clm. and (track groove trench) with	-	2004/09/27
		(dimension width)	US-PGPUB;	14:40
		(amount width)	EPO; JPO; DERWENT;	
			· ·	
_	722	((disc magnetic adj recording magnetic adj	IBM_TDB USPAT;	2004/00/07
		medium).ti,ab,clm. and (track groove trench) with	US-PGPUB;	2004/09/27 14:33
		(dimension width)) and (micron ".mu." micrometer)	EPO; JPO;	14.00
		(inclonetel)	DERWENT;	
	ļ		IBM_TDB	
Search Histo	0.100.10	4.5.10.10 DM D 14	.2111_1 DD	

		· ·		
-	237		USPAT;	2004/09/27
		medium).ti,ab,clm. and (track groove trench) with	US-PGPUB;	14:33
		(dimension width)) and (micron ".mu." micrometer))	EPO; JPO;	
		and (magnetic adj film magnetic adj layer)	DERWENT;	
	42	W.B	IBM_TDB	
_	43	,,,,	USPAT;	2004/09/27
		medium).ti,ab,clm. and (track groove trench) with	US-PGPUB;	14:34
		(dimension width)) and (micron ".mu." micrometer))	EPO; JPO;	
		and (magnetic adj film magnetic adj layer) with	DERWENT;	
	5417	(depth height dimension)	IBM_TDB	2004/00/07
-	3417	(optical adj disc magnetic adj recording magnetic adj medium).ti,ab,clm. and (track groove trench)	USPAT;	2004/09/27
		with (dimension width)	US-PGPUB;	16:46
		with (differential)	EPO; JPO;	
			DERWENT;	
	266	((optical adj disc magnetic adj recording magnetic	IBM_TDB	0004 /00 /07
	200	adj medium).ti,ab,clm. and (track groove trench)	USPAT;	2004/09/27
		with (dimension width)) and (magnetic adj layer	US-PGPUB; EPO; JPO;	14:41
		magnetic adj film) with (depth height dimension)	DERWENT;	
			IBM_TDB	
_	230	(((optical adj disc magnetic adj recording magnetic	USPAT;	2004/09/27
		adj medium).ti,ab,clm. and (track groove trench)	US-PGPUB;	15:55
	1	with (dimension width)) and (magnetic adj layer	EPO; JPO;	10.00
		magnetic adj film) with (depth height dimension))	DERWENT;	
		not ((((disc magnetic adj recording magnetic adj	IBM_TDB	
		medium).ti,ab,clm. and (track groove trench) with	IBM_IBB	
		(dimension width)) and (micron ".mu." micrometer))		
		and (magnetic adj film magnetic adj layer) with		Ì
1		(depth height dimension))		
-	2	WO-9803972-\$.did. JP-1040544-\$.did.	EPO; JPO;	2004/09/27
		JP-1125455-\$.did.	DERWENT	15:56
-	5	WO-9803972-\$.did. JP-10040544-\$.did.	EPO; JPO;	2004/09/27
		JP-11025455-\$.did.	DERWENT	15:56
-	8	("3099571" "4391849" "4472240" "4875987"	USPAT	2004/09/27
		"4911967" "4935278" "5336586"		16:22
		"5350618").PN.		
-	4	5580639.URPN.	USPAT	2004/09/27
				16:24
-	96	((optical adj disc magnetic adj recording magnetic	USPAT;	2004/09/27
[adj medium).ti,ab,clm. and (track groove trench)	US-PGPUB;	16:47
		with (dimension width)) and (fill deposit cover) with	EPO; JPO;	
		(magnetic adj film magnetic adj layer)	DERWENT;	
	5	("4195497" "4180439" "4050433" "4350561"	IBM_TDB	2004/00/07
_	3	("4125427" "4180432" "4259433" "4350561" "4512848").PN.	USPAT	2004/09/27
_	18	4724043.URPN.	I I C D A T	17:05
	13	112 10TO.OIXI IX.	USPAT	2004/09/27
_	1	1992-345755.NRAN.	DEDITIENA	17:06
	*	2552 010100.MQM.	DERWENT	2004/09/27 17:53
_	0	EP-0120990-\$.did.	USPAT;	2004/09/27
			US-PGPUB;	18:20
			EPO; JPO;	10.20
			DERWENT;	
			IBM_TDB	
-	0	EP-0120990-\$.did.	EPO	2004/09/27
			- -	18:21
~	0	0120990-\$.did.	EPO	2004/09/27
				18:21
-	0	"0120990"	EPO	2004/09/27
				18:21
-	36	"0120990"	EPO;	2004/09/27
			DERWENT	18:24

				
-	2	JP-61100910-\$.did.	EPO; JPO;	2004/09/27
			DERWENT	18:26
-	2	JP-61054857-\$.did.	EPO; JPO;	2004/09/27
			DERWENT	18:27
-	0	EP-0120990-\$.did.	EPO; JPO;	2004/09/27
			DERWENT	18:27
-	2	EP-120990-\$.did.	EPO; JPO;	2004/09/27
			DERWENT	18:28
-	1	WO-8809979-\$.did.	EPO; JPO;	2004/09/27
			DERWENT	18:28